

Lo-Void Solder Paste

UK manufactured RoHS and REACH compliant lead-free solder paste

Low voiding, high fill, superior wetting, J-STD 004B ROL1 and ROL0 formulations

Excellent print characteristics utilizing type 4 (20-38 μm) and type 5 (15-25 μm) powder

Printer and operator friendly offering >3 days open time and tackiness time

Supplied in all lead free SAC alloys and bismuth alloys

12 months storage, long life



www.solderking.com